



Docket No.: 0152-0703PUS1
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Hisashi YAMADA et al.

Application No.: 10/524,013

Confirmation No.: 7576

Filed: February 8, 2005

Art Unit: 2823

For: METHOD FOR PRODUCING COMPOUND
SEMICONDUCTOR WAFER AND
COMPOUND SEMICONDUCTOR DEVICE

Examiner: M. Estrada

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated April 17, 2006, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 4 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 5 of this paper.